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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Attn: OIPE

Masatake NAKANO

Application No.: 10/500,381

Docket No.: 120164

Filed: June 29, 2004

For: METHOD OF PRODUCING SOI WAFER AND SOI WAFER

REQUEST FOR CORRECTION OF PALM RECORDS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Attached is a photocopy of the original filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records. A Supplemental Application Data Sheet is attached.

Respectfully submitted,

James A. Oliff
Registration No. 27,075

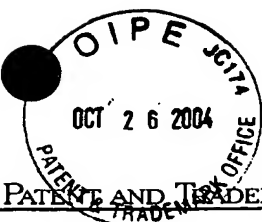
Thomas J. Pardini
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JAO:TJP/mps

Date: October 26, 2004

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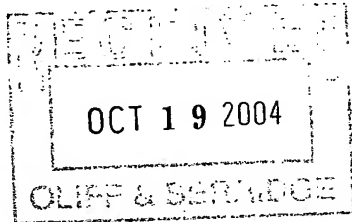


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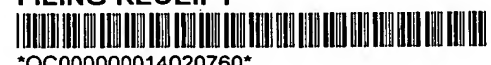
APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/500,381	06/29/2004	2812	920	120164	3	16	2

25944
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CONFIRMATION NO. 9028

FILING RECEIPT



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Date Mailed: 10/15/2004

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Applicant(s)

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Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/00034 01/07/2003

Foreign Applications

JAPAN 2002-001942 01/09/2002

Projected Publication Date: To Be Determined - pending completion of Security Review

Non-Publication Request: No

Early Publication Request: No

Title

~~Sei wafer manufacturing method and sei wafer~~**METHOD OF PRODUCING SOI WAFER
AND SOI WAFER**

Preliminary Class

438

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ATTORNEYS AT LAW

Application Data Sheet**Application Information**

Application Type:: National Phase
Subject Matter:: Utility
CD-ROM or CD-R: None
Title:: METHOD OF PRODUCING SOI WAFER AND SOI WAFER
Attorney Docket Number:: 120164
Total Drawing Sheets:: 3
Small Entity:: No

Applicant Information

Applicant Authority type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Masatake
Family Name:: NAKANO
City of Residence:: Gunma
Country of Residence:: Japan

Correspondence Information

Correspondence Customer Number:: 25944

Domestic Priority Information			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP03/00034	01/07/2003
Foreign Priority Information			
Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-1942	01/09/2002	Yes
Assignee Information			
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